**Taiwan I&C Standard Committee**

**Meeting Summary and Minutes**

Taiwan I&C TC Meeting

September 9, 2016 (Fri),15:30-16:30

Ambassador Hotel Hsinchu ; Conference Room: 13F, Mezzanine AB

(188 Chung Hwa Road Section 2, Hsinchu, Taiwan, R. O. C. )

**Next Committee Meeting**

March, 2017 (TBD)

SEMI Taiwan office

**Committee Announcements (optional)**

•None

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| **Meeting Attendees :** **(29 Attendees, 26 have rights to vote)** **Co-chairs:** Robert Chien (TSMC) **SEMI Staff:** Dean Chang (SEMI Taiwan), James Amano (SEMI HQ)  |
| *Company* | *Last* | *First* | *Company* | *Last* | *First* |
| Chiff Technology Inc | HSu | K.H. | TSMC | Chen | Ivan |
| ASE | Lee | Peter | TSMC | Liao | Robin |
| SPIL | Jian | Leon | TSMC | Chiu | Kevin |
| SPIL | Huang | Yih-Shyan | Belfor | Wu | Bright |
| Flagship | Huang | Jack | Atotech | Chiu | David |
| Evertak Technology | Wang | Jeff | ITRI | Chen | Chi-Pin |
| TPCA | Hung | Michelle | Wuchine | Ho | Rick |
| TPCA | Yang | Sylvia | Symtek | Chang | Chi-Yuan |
| Nanya | Hsu | Dolven | Nanya | Lin | Dylan |
| Career | Tsai | KunYuan | Advantech | Chen | Hock |
| Tripod | Teng | Daniel | Abontech | Chin | Joshua |
| MIRDC | Tsai | Nate | Is-Land | Chu | Amy |
| Symtek | Chien | James | TSMC | Chua | M.T. |
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| **Leadership Changes :** None |
| **Ballot Results (or move to Section 4, Ballot Review)****Passed** ballots and line items will be submitted to the ISC Audit & Review Subcommittee for procedural review.None |
| **Authorized Ballots (or move to Section 7, New Business)**None |

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| **Authorized Activities (or move to Section 7, New Business)**

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| *#* | *Type* | *SC/TF/WG* | *Details* |
| 1 | TFOF | PCB Equipment Communication Interfaces (PCBECI) TF | To define the guide for Printed Circuit Board (PCB) equipment communication interfaces that use in PCB manufacturing lines |
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Note: SNARFs and TFOFs are available for review on the SEMI Web site at:

<http://downloads.semi.org/web/wstdsbal.nsf/TFOFSNARF>

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| **New Action Items (or move to Section 8, Action Item Review)****Previous Meeting Actions Items** **(or move to Section 8, Action item Review)** |

1. **Welcome, Reminders, and Introductions**

Mr. Robert Chien (TSMC) called the meeting to order at 15:30. After welcoming all attendees, the SEMI meeting reminders on antitrust issues, intellectual property issues and practices for international attendance were reviewed. Attendees introduced themselves.

**2. Review of Previous Meeting Minutes**

The committee reviewed the previous meeting material.

*Attachment : SEMI Taiwan I&C TC Meeting Minutes 20160408*

* + Motion: Approve previous meeting minutes
	+ By / 2nd: Iven Chen (TSMC) / Dolven Hsu (Nanya)
	+ Discussion: After review,
	+ Vote: 20-0-6 Motion passed.

**3. Staff Report and Liaison Report**

* Liaison Report –
	+ NA & HQ

*Attachment: NA I&C Liaison Report Aug 2016*

* Japan

*Attachment:* *160704\_JA-ICC\_Liaison\_v1.0*

* + Korea

*Attachment:* *KR\_I&C\_liaison\_Sept*

* Staff report:
	+ Updates on SEMI activities.

*Attachment : Staff Report 20160909*

**4. Ballot Review**

None

**5. Task Force Update**

* GEM300 TF Report :
* Introduce “Incoming Material Quality Control”.
* Equipment Information Integration TF Report : None
* Backend Factory Integration TF Report:
* Study the feedback of New SNARF “Specification of Backend Die Traceability” from the I&C global TC members and will discuss with TF members how to modify the SNARF..

**6. Old Business**

* Continue to invite and recruit new members (ongoing)
* SEMI to help leverage the resources of I&C committees in other regions as well as resources in other technical committees like 3DS-IC (ongoing)
* Contact with Japan Equipment Information System Security (EISS) TF to get the presented material for SEMI Korea I&C Workshop. (completed)
* Assign Equipment Information TF leader Robin Liao (TSMC) to study “material QA management” and report to members in next TC meeting. (completed)
* SEMI Taiwan staff will send the document #5601A to SEMI Taiwan TC members and collect the comment from members.(completed)
1. **New Business**
* Submitted the TFOF (see attached file) to HQ to set up new Task Force: “PCB TF” ,
* Motion: Approve set up a new Task Force: “PCB TF”
* By / 2nd: Rick Ho (Wuchine) / Hung Michelle (TPCA)
* Discussion: After review, all TC members agreed to approve it.
* Vote: 26-0-0 Motion passed.
* Study the Standards of Information Security topic for next TC meeting.
1. **Action Item Review**
* Remind new members to select TF to join (by SEMI staff)
* Invite the expert of information security to introduce the related standards in next TC.
1. **Next Meeting and Adjournment**

March, 2017 (TBD); SEMI Taiwan office

**Respectfully submitted by:**

**Dean Chang**

**SEMI Taiwan**

**Phone:+ 886 3 560 1777**

**Email:** **dchang@semi.org**

Minutes approved by:

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| Robert Chien, committee chair | <Date approved>  |

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| **Index of Available Attachments #1** |
| *#* | *Title* | *#* | *Title* |
| 1 | *Meeting minutes 20160408* | 5 | *Staff Report 20160909* |
| 2 | *NA I&C Liaison Report Aug 2016* | 6 | *SEMI\_TFOF FORM\_PCB\_20160701* |
| 3 | *160704\_JA-ICC\_Liaison\_v1.0* | 7 |  |
| 4 | *KR\_I&C\_liaison\_Sept* |  |  |
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1. Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.